Features

- 1206 SMD LED
- Close responsively to the human eye spectrum
- Light to Current, analog output
- Good output linearity across wide illumination range
- Low sensitivity variation across various light sources

Applications

- Infrared application system
- Optoelectronic automatic control system
- Optoelectronic switch
- Printer
- Counters and sorters
- Encoders
- Floppy disk drive
- Video camera, tape and card readers
- Position sensors

Description

The IN-S126BTNPT is a popular 1206 package with versatile design capabilities. It is a PCB type LED which can be used in various applications. Due to its **black** epoxy, the device is matched to visible light and infrared radiation.

Recommended Solder Pattern

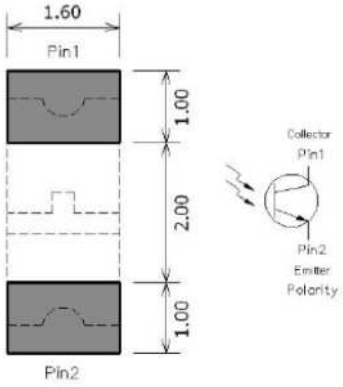
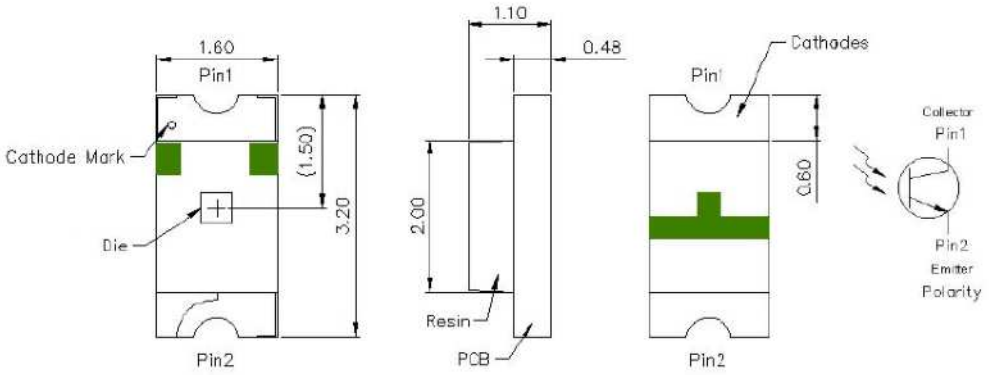


Figure 1. IN-S126BTNPT Solder Pattern

Package Dimensions in mm



Notes.
1. All dimensions are in millimeters.
2. Tolerance is ± 0.10 mm unless otherwise noted

Figure 2. IN-S126BTNPT Package Dimensions

Absolute Maximum Rating at 25ºC

Symbol	Parameters	Ratings	Units	Notes
BV_{CEO}	Collector-Emitter Breakdown Voltage	35	V	1
BV_{ECO}	Emitter-Collector Breakdown Voltage	5	V	2
I_C	Collector Current	20	mA	
T_{opr}	Operating Temperature	-40~+85	℃	
T_{stg}	Storage Temperature	-40~+100	℃	
T_{sol}	Soldering Temperature	260	℃	3
P_{to}	Total Power Dissipation	150	mW	

Notes

1. Test conditions: I_C=100μA, E_e=0mW/cm2.
2. Test conditions: I_E=100μA, E_e=0mW/cm2.
3. Soldering time≦5 seconds.

ESD Precaution

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly.
If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

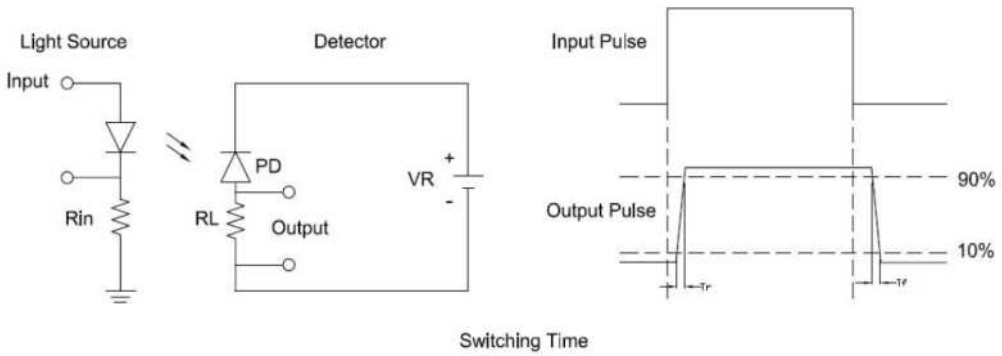
Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

Electro-Optical Characteristics

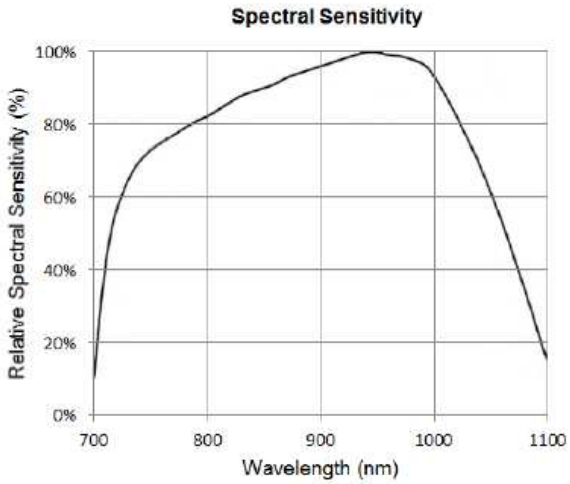
Symbol	Parameters	Test conditions	Min	Typ	Max	Units	Notes
λD	Rang Of Spectral Bandwidth	---	750	-	1100	nm	
λP	Wavelength Of Peak Sensitivity	---	-	940		nm	
BVCEO	Collector-Emitter Breakdown Voltage	IC=100μA Ee=0mW/cm²	-	30	-	V	
BVECO	Emitter-Collector Breakdown Voltage	IE=100μA Ee=0mW/cm²	-	5	-	V	
VCE(sat)	Collector-Emitter Saturation Voltage	IC=2mA Ee=1mW/cm²	-	-	0.4	V	
ICEO	Collector Dark Current	VCE=20V Ee=0mW/cm²	-	-	100	nA	
IC(ON)	On State Collector Current	Ee=1mW/cm² λP=940nm, VCE=5V	0.1	0.5	0.8	mA	
tr	Rise Time	VCE=5V, IC=1mA RL=1000Ω	-	15	-	uS	4
tf	Fall Time		-	15	-	uS	4

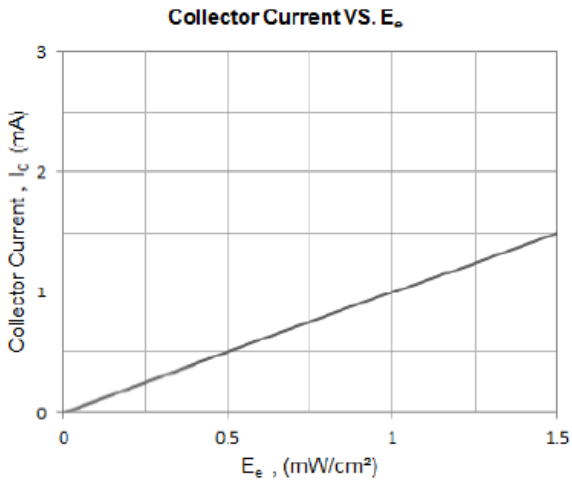
Notes

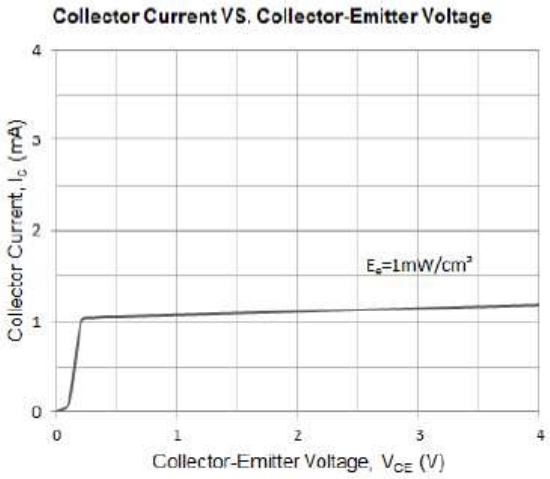
4. Test circuit：



Typical Characteristic Curves



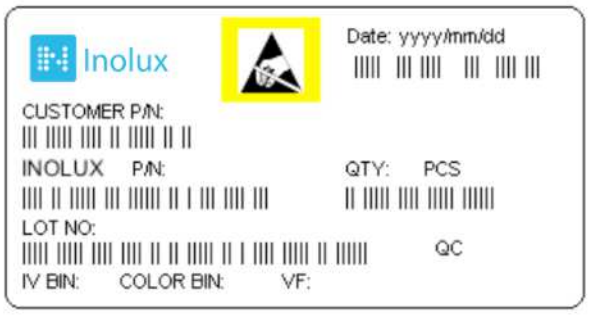




Ordering Information

Product	Symbol	Parameters	Test conditions	Min	Typ	Max	Units	Orderable Part Number
IN-S126BTNPT	$I_{C(ON)}$	On State Collector Current	Ee=1mW/cm² λ_P=940nm, V_{CE}=5V	0.1	0.5	0.8	mA	IN-S126BTNPT

Label Specifications



Inolux P/N:

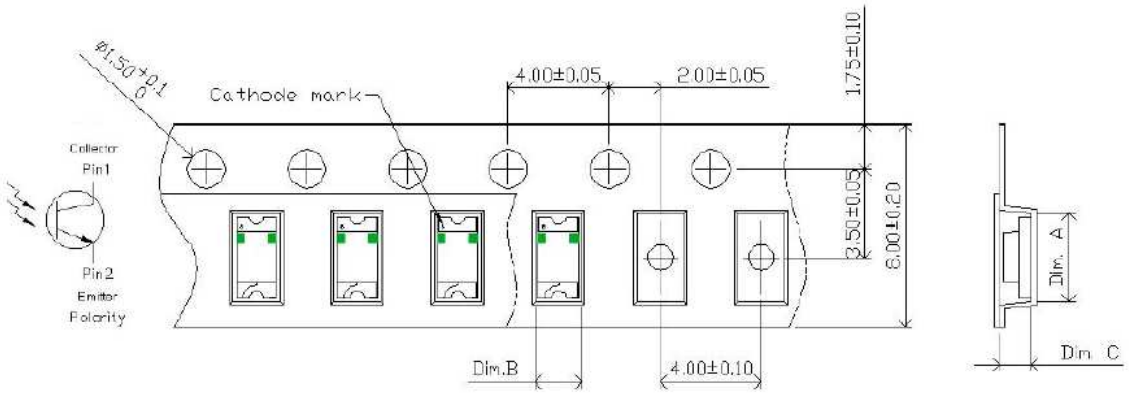
I	N	-	S	126	B	T	N	PT	-	-	-	-	-
			Material	Package	Variation	Orientation	Lens	Color		Customized Stamp-off			
Inolux SMD			PCB - S	126B = 1206 smaller molder series		T = Top Mount	N = Black	PT = Photo Transistor					

Lot No.:

Z	2	0	1	7	01	24	001
Internal Tracker	Year (2017, 2018, …..)				Month	Date	Serial

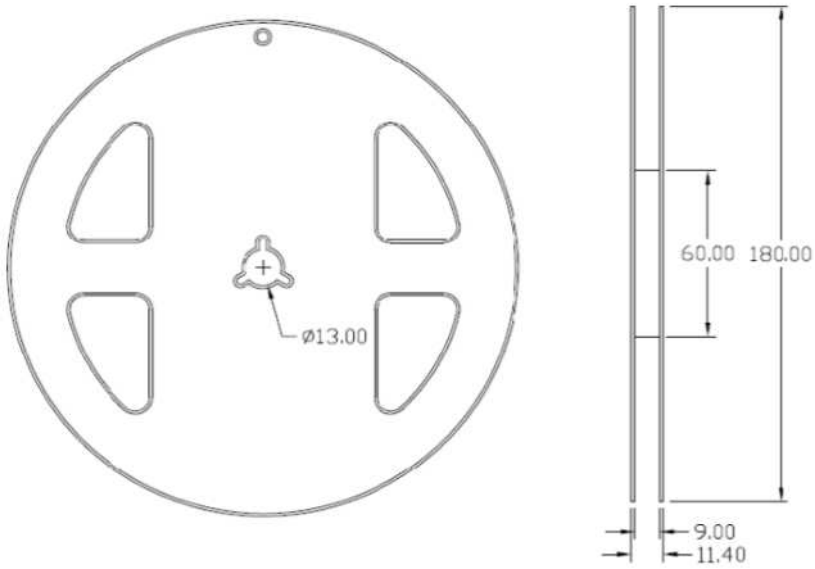
Packaging Information:

Packaging
Tape Dimension

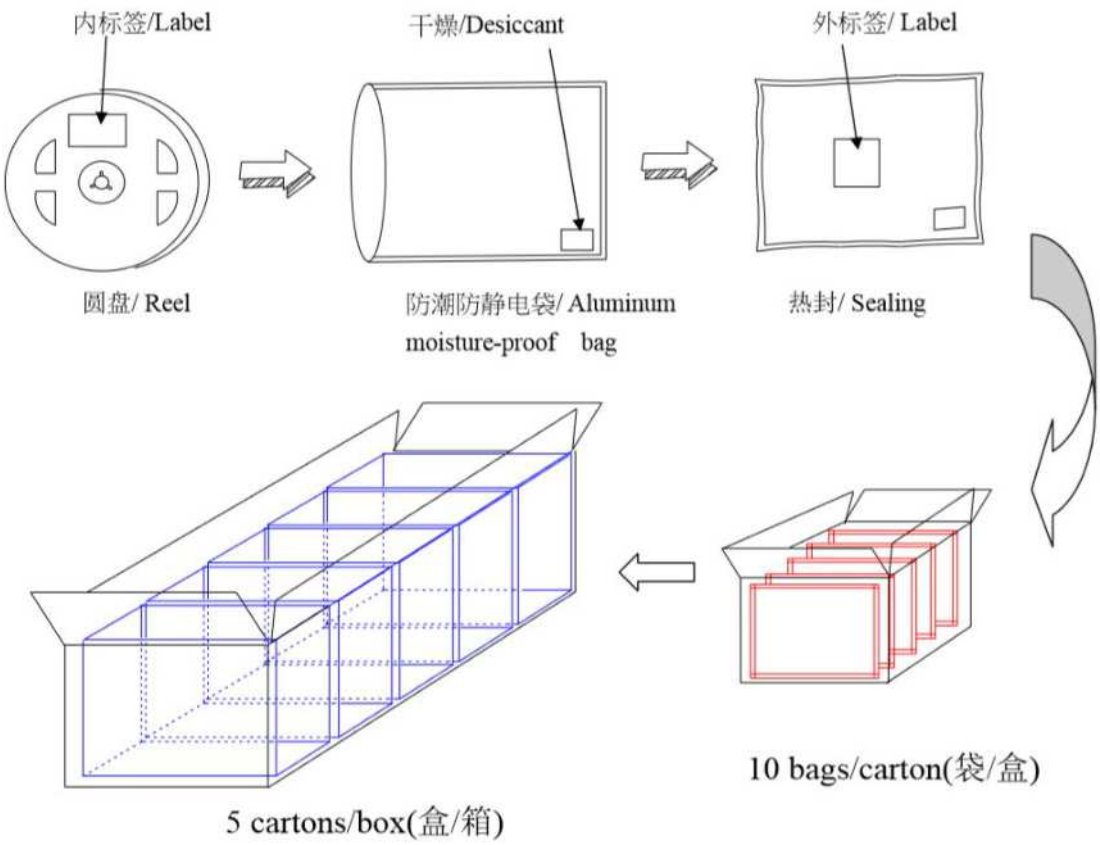


Dim. A	Dim. B	Dim. C	Q'ty/Reel
3.50±0.05	1.88±0.05	1.27±0.05	3K

Reel Dimension



Packing Dimension



5 boxes per carton are available depending on shipment quantity.

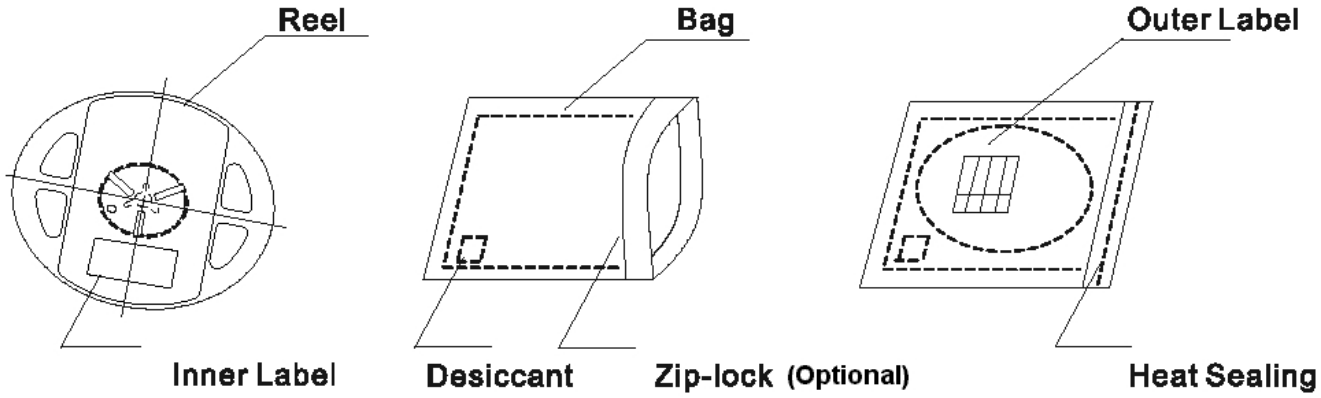
	Specification	Material	Quantity
Carrier tape	Per EIA 481-1A specs	Conductive black tape	3000pcs per reel
Reel	Per EIA 481-1A specs	Conductive black	
Label	IN standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	IN standard	Paper	Non-specified
Others: Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin. Each reel has a label identifying its specification; the immediate box consists of a product label as well.			

Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

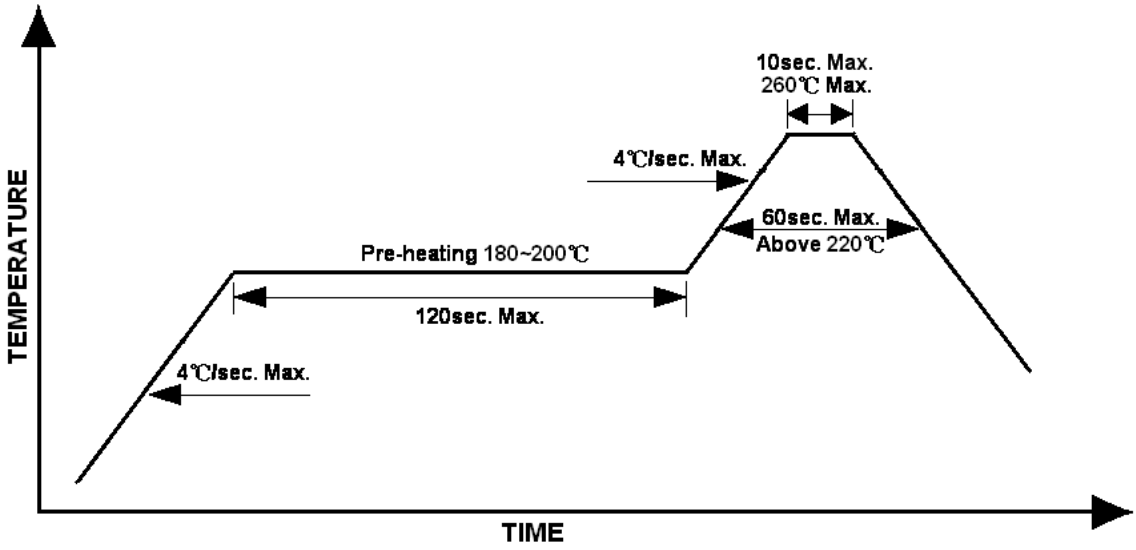
The packaging sequence is as follows:



Reflow Soldering

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):

Lead-free Solder Profile



Precautions

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

Reworking

- Rework should be completed within 5 seconds under 260 ^{O}C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50^{o}C x 30sec. or <30^{o}C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 ^{O}C max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

Reliability

Item	Frequency/ lots/ samples/ failures	Standards Reference	Conditions
Precondition	For all reliability monitoring tests according to JEDEC Level 2	J-STD-020	1.) Baking at 85°C for 24hrs 2.) Moisture storage at 85°C/ 60% R.H. for 168hrs
Solderability	1Q/ 1/ 22/ 0	JESD22-B102-B And CNS-5068	Accelerated aging 155°C/ 24hrs Tinning speed: 2.5+0.5cm/s Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+1s
Resistance to soldering heat		CNS-5067	Dipping soldering terminal only Soldering bath temperature A: 260+/-5°C; 10+/-1s B: 350+/-10°C; 3+/-0.5s
Operating life test	1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85°C baking for 24hrs 85°C/ 60%R.H. for 168hrs 2.) Tamb25°C; IF=20mA; duration 1000hrs
High humidity, high temperature bias	1Q/ 1/ 45/ 0	JESD-A101-B	Tamb: 85°C Humidity: 85% R.H., IF=5mA Duration: 1000hrs
High temperature bias	1Q/ 1/ 20	IN specs.	Tamb: 55°C IF=20mA Duration: 1000hrs
Pulse life test	1Q/ 1/ 40/ 0		Tamb25°C, If=20mA,, Ip=100mA, Duty cycle=0.125 (tp=125 μs,T=1sec) Duration 500hrs)
Temperature cycle	1Q/ 1/ 76/ 0	JESD-A104-A IEC 68-2-14, Nb	A cycle: -40 degree C 15min; +85 degree C 15min Thermal steady within 5 min.. 300 cycles 2 chamber/ Air-to-air type
High humidity storage test	1Q/ 1/ 40/ 0	CNS-6117	60+3°C 90+5/-10% R.H. for 500hrs
High temperature storage test	1Q/ 1/ 40/ 0	CNS-554	100+10°C for 500hrs
Low temperature storage test	1Q/ 1/ 40/ 0	CNS-6118	-40+5°C for 500hrs

Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	01-31-2019

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